

## **Vishay Siliconix**

# N-Channel 150-V (D-S) MOSFET

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	$r_{DS(on)}(\Omega)$	I <sub>D</sub> (A)	Q <sub>g</sub> (Typ)		
150	0.135 @ V <sub>GS</sub> = 10 V	3.4	20 nC		
	0.142 @ V <sub>GS</sub> = 6 V	3.3	20110		

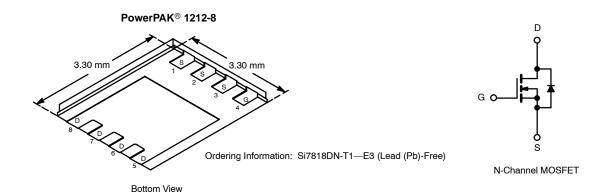
#### **FEATURES**

- PWM-Optimized TrenchFET® Power MOSFET
- 100% R<sub>g</sub> Tested
  Avalanche Tested

COMPLIANT

#### **APPLICATIONS**

• Primary Side Switching Circuits



ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^{\circ}C$ UNLESS OTHERWISE NOTED)						
Parameter		Symbol	10 secs	Steady State	Unit	
Drain-Source Voltage		V <sub>DS</sub>	150			
Gate-Source Voltage		V <sub>GS</sub>	±20		V	
0.11. 0.1.0.1.0.1.0.0.0.0.0.0.0.0.0.0.0.	T <sub>A</sub> = 25°C	- I <sub>D</sub>	3.4	2.2		
Continuous Drain Current (T <sub>J</sub> = 150°C) <sup>a</sup>	T <sub>A</sub> = 70°C		2.7	1.7		
Pulsed Drain Current		I <sub>DM</sub>	10		Α	
Continuous Source Current (Diode Conduction) <sup>a</sup>		I <sub>S</sub>	3.2	1.3		
Single Avalanche Current		I <sub>AS</sub>	9			
Single Avalanche Energy	L = 0.1 mH	E <sub>AS</sub>	4		mJ	
Maximum Power Dissipation <sup>a</sup>	T <sub>A</sub> = 25°C	Б	3.8	1.5	w	
	T <sub>A</sub> = 70°C	P <sub>D</sub>	2.0	0.8		
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	-55 to 150 260		°C	
Soldering Recommendations (Peak Temperature) <sup>b, c</sup>						

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
	t ≤ 10 sec	R <sub>thJA</sub>	26	33	°C/W	
Maximum Junction-to-Ambient <sup>a</sup>	Steady State		65	81		
Maximum Junction-to-Case (Drain)	Steady State	R <sub>thJC</sub>	1.9	2.4		

- Surface Mounted on 1" x 1" FR4 Board.
- See Reliability Manual for profile. The PowerPAK 1212-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder
- Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

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### **New Product**



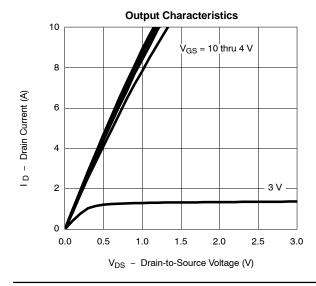
Parameter	Symbol	Test Condition	Min	Тур	Max	Unit	
Static	l l		L				
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \mu A$	2		4	٧	
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS}$ = 0 V, $V_{GS}$ = $\pm 20$ V			±100	nA	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS} = 150 \text{ V}, V_{GS} = 0 \text{ V}$			1	μА	
		$V_{DS} = 150 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55^{\circ}\text{C}$		5			
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	10			Α	
Drain-Source On-State Resistance <sup>a</sup>	r <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 3.4 A		0.112	0.135	Ω	
Dialii-Source Oil-State Resistance		$V_{GS} = 6 \text{ V}, I_D = 3.3 \text{ A}$		0.117	0.142		
Forward Transconductancea	9 <sub>fs</sub>	$V_{DS} = 15 \text{ V}, I_D = 3.4 \text{ A}$		17		S	
Diode Forward Voltage <sup>a</sup>	V <sub>SD</sub>	$I_S = 3.2 \text{ A}, V_{GS} = 0 \text{ V}$		0.78	1.2	V	
Dynamic <sup>b</sup>							
Total Gate Charge	Qg			20	30	nC	
Gate-Source Charge	Q <sub>qs</sub>	$V_{DS} = 75 \text{ V}, \ V_{GS} = 10 \text{ V}, \ I_{D} = 3.4 \text{ A}$		2.7			
Gate-Drain Charge	Q <sub>gd</sub>			4.7		1	
Gate Resistance	R <sub>g</sub>	f = 1 MHz	0.8	1.7	2.6	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			10	15		
Rise Time	t <sub>r</sub>	V <sub>DD</sub> = 100 V. R <sub>I</sub> = 100 Ω		10	15		
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{DD}$ = 100 V, $R_L$ = 100 $\Omega$ $I_D \cong$ 1 A, $V_{GEN}$ = 10 V, $R_g$ = 6 $\Omega$		25	40	ns	
Fall Time	t <sub>f</sub>			15	25		
Source-Drain Reverse Recovery Time	t <sub>rr</sub>	1 00A E/E 100A/		50	75	1	
Reverse Recovery Charge	Q <sub>rr</sub>	$I_F = 3.2 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}$		100	150	nC	

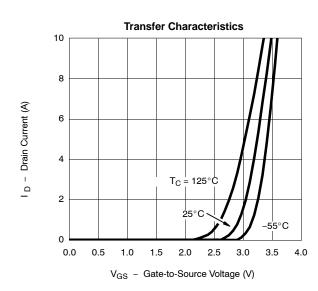
#### Notes

- a. Pulse test; pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2%.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

#### TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)

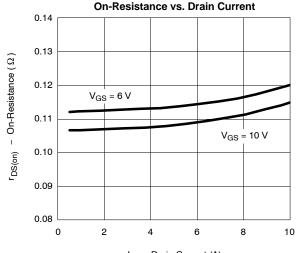




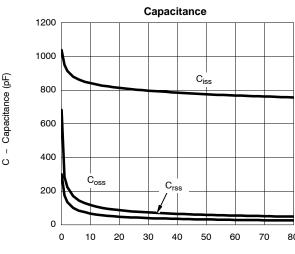




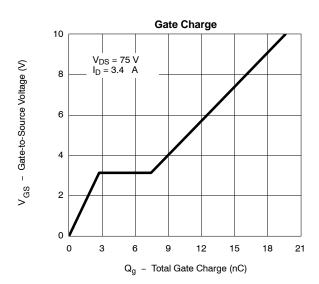
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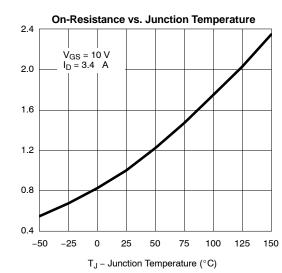




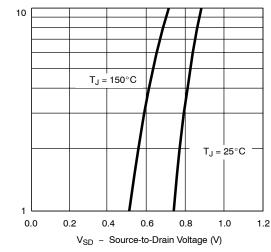
V<sub>DS</sub> - Drain-to-Source Voltage (V)



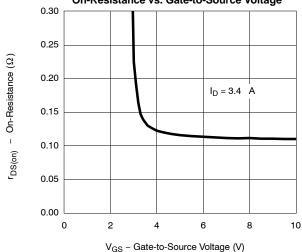
r<sub>DS(on)</sub> - On-Resiistance (Normalized)



Source-Drain Diode Forward Voltage



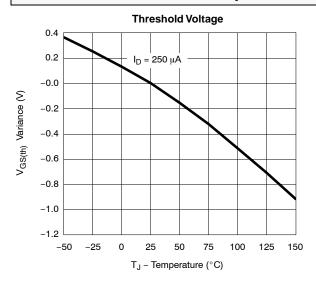


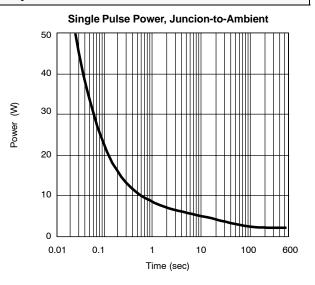


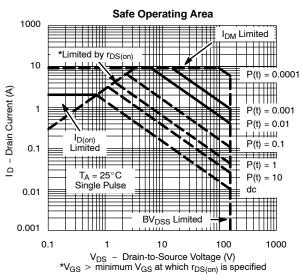
Source Current (A)



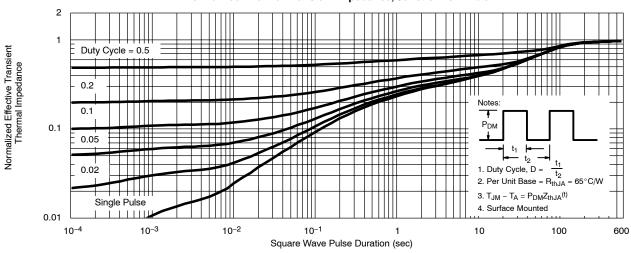
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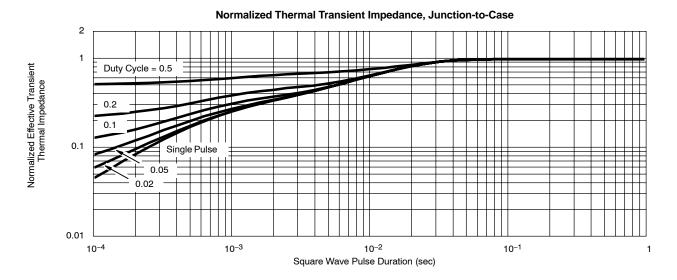
#### Normalized Thermal Transient Impedance, Junction-to-Ambient





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#### TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)



Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg?73252">http://www.vishay.com/ppg?73252</a>.



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